The circuit is designed for SN65HVD72, not SN65HVD485. The latter requires 5V supply.

Place close to pin 39
Place close to pin 21
Place close to pin 10
Place close to pin 31
Place close to pin 24
Place close to pin 27, 28 and 29

Place holder for a large capacitor if needed close to power supply.

Debug header
FIDU1
FIDU2
FIDU3

Test pin header

2.0mm Plated mounting holes
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